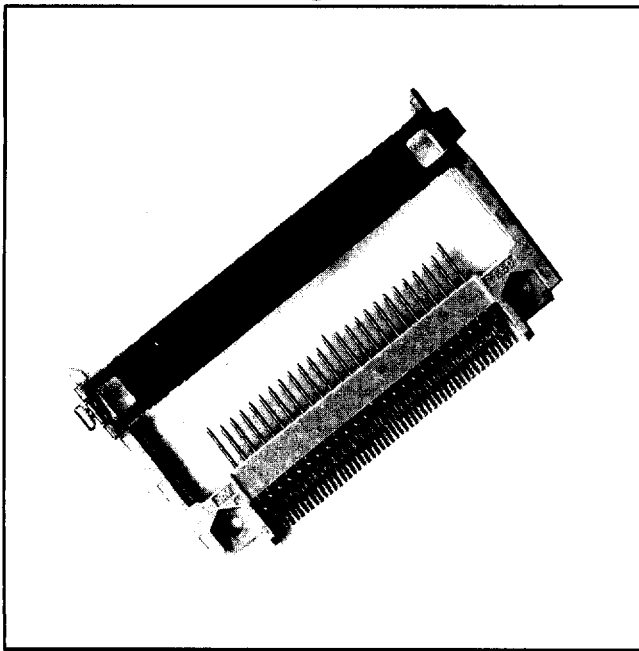


.050" × .050" CF Card Low Profile Header

Surface Mount, Long Guides



- Low profile — 4.0 mm height
- Board component clearance — 0.0 mm standoff
- Cost savings — eliminates need for molded guide rails in equipment
- Single row solder tails — 0.635 mm spacing
- Meets CFA standards — known reliability

TS-0765-01
Sheet 1 of 3

Physical

Insulation

Material: Liquid Crystal Polyester (LCP)
Flammability: UL 94V-0
Color: Beige

Contact

Material: Copper Alloy
Plating
Underplate: 100 μ " [2.54 μ m] Nickel — QQ-N-290, Class 2
Wiping Area: Gold Flash over 20 μ " [0.50 μ m] 80/20 Palladium Nickel
Solder Tails: 50 μ " [1.27 μ m] 85/15 Tin Lead — MIL-P-81728

Electrical

Current Rating: .5 A
Insulation Resistance: $>1 \times 10^9 \Omega$ at 500 Vdc
 $>1 \times 10^8 \Omega$ at 500 Vdc after Environmental Conditioning
Withstanding Voltage: 500 Vrms at Sea Level

Environmental

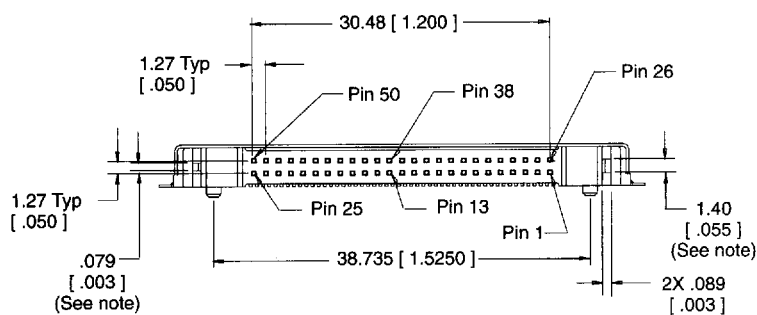
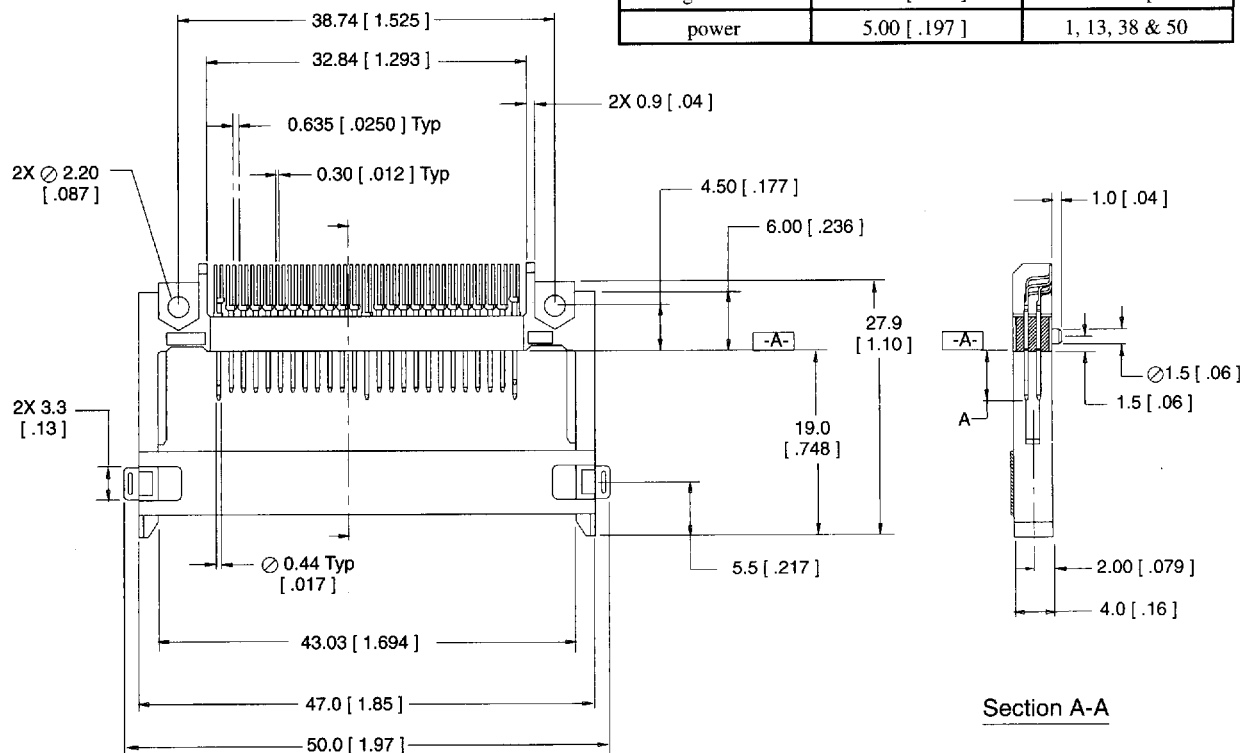
Temperature Rating: -55°C to $+85^\circ\text{C}$
Process Rating: Maximum 235°C , with 90 seconds over 215°C

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.050" × .050" CF Card Low Profile Header

Surface Mount, Long Guides

Pin Type	Interface Dim A	Pin No.
detect	3.50 [.138]	25, 26
general	4.25 [.167]	all other pins
power	5.00 [.197]	1, 13, 38 & 50



mm
[Inch]

Tolerance Unless Noted			
	.0	.00	.000
mm	±.3	±.13	

[] Dimensions for
Reference only

Note: Inverse style is shown. For normal style, rotate polarization keys and pin call outs 180°.

Ordering Information

N7E50-X516VY-30

Options: CF Card Polarization / Solder Tabs / Ejector:
F = Inverse / with solder tab / ejector not acceptable

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Sheet 2 of 3

Surface Mount, Long Guides



Recommended PCB Solder Pad Pattern

19F 9035312 0004212 170